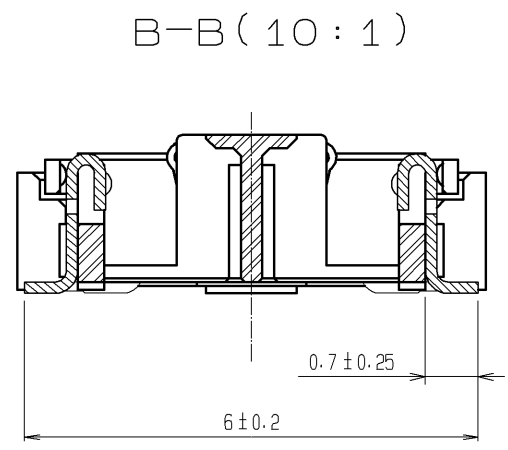
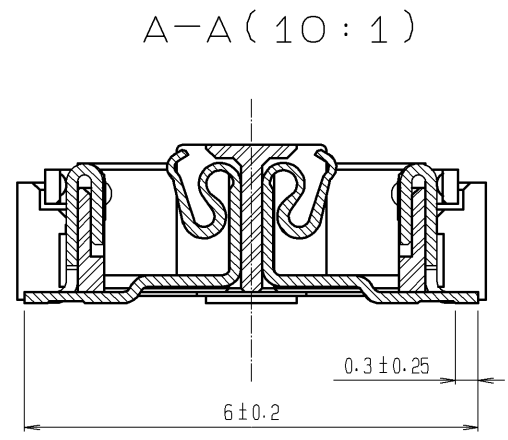
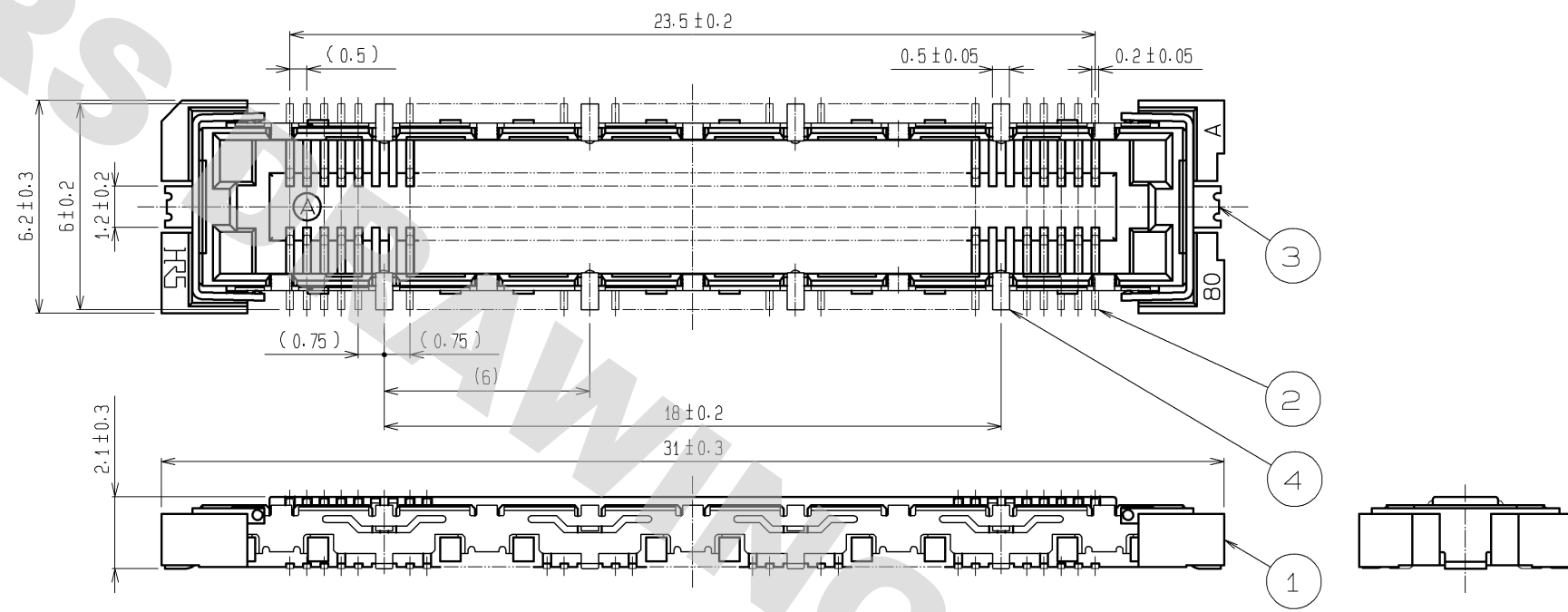
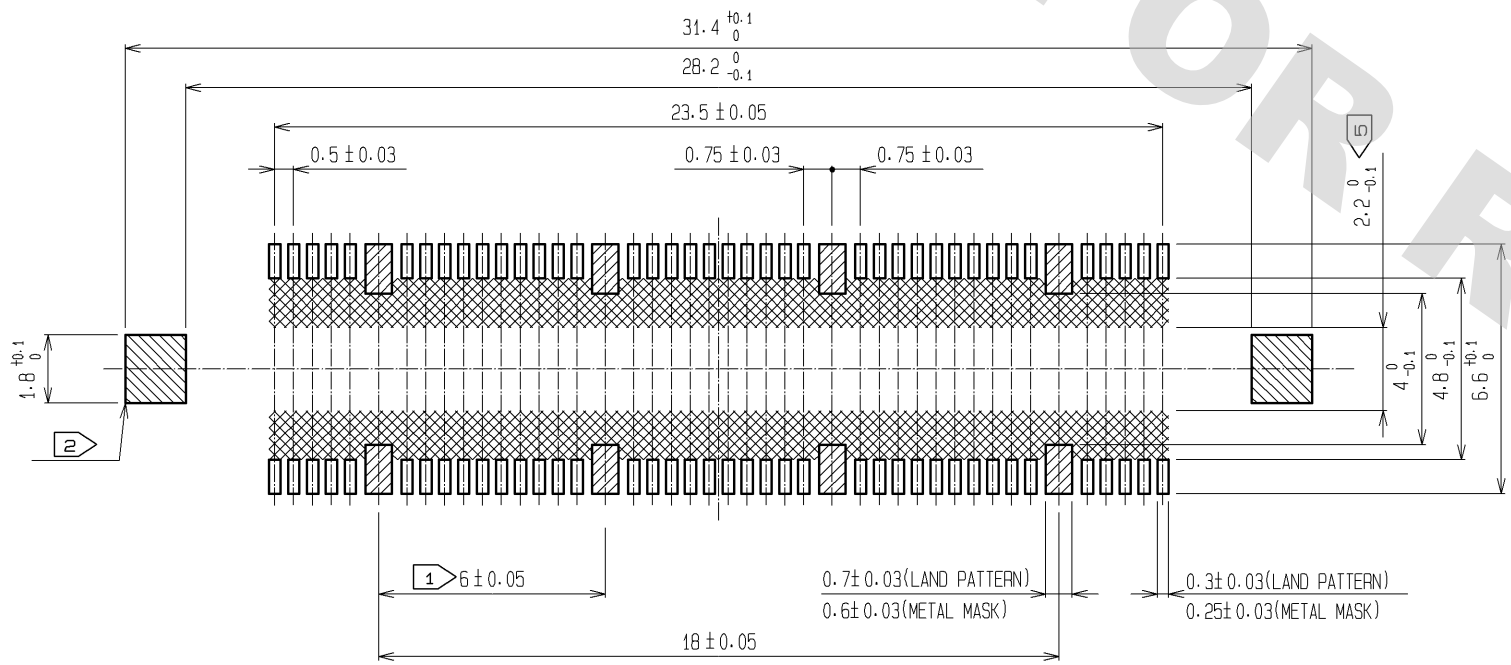


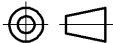
DRAWING FOR REFERENCE: This is subject to change without notice
08/11/2012



RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)



- NOTES
- ① 8 HATCHED PARTS: GROUND CIRCUIT.
 - ② 2 HATCHED PARTS: GROUND CIRCUIT.
 - ③ SMT LEAD-COPLANARITY: 0.1 MAX.
 - ④ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND .OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - ⑥ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

					3, 4	PHOSPHOR BRONZE	TIN PLATING				
					2	PHOSPHOR BRONZE	CONTACT AREA : GOLD 0.1μm min.				
							LEAD AREA : GOLD 0.05μm min.				
							UNDER PLATING : NICKEL 1μm min.				
1	LCP		BEIGE		UL94V-0						
NO.		MATERIAL		FINISH . REMARKS		NO.	MATERIAL		FINISH . REMARKS		
UNITS				SCALE		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
mm				5 : 1							
 HIROSE ELECTRIC CO., LTD.				APPROVED : HS. OKAWA		09.10.19		DRAWING NO. EDC3-152637-25			
				CHECED : HT. YAMAGUCHI		09.10.19		PART NO. FX11B-80S/8-SV(71)			
				DESIGNED : SY. KAMIGA		09.10.17		CODE NO. CL573-0713-5-71			
				DRAWN : HK. SUNADORI		09.10.17					
										1	1